

OBSOLETE - PART DISCONTINUED

Product Summary

V _{RRM} (V)	I _O (A)	V _F MAX (mV)	I _R MAX (μA)
30	1	525	100

Description

The DIODES SDM1A30CSP is a 30V 1A Schottky barrier rectifier that is optimized for low forward voltage drop and low-leakage current, housed in a compact chip scale package (CSP) that occupies only 0.6mm² board space. The low thermal resistance enables designers to meet design challenges of increasing efficiency while also reducing board space.

Applications

The SDM1A30CSP are ideally suited for use in portable applications as:

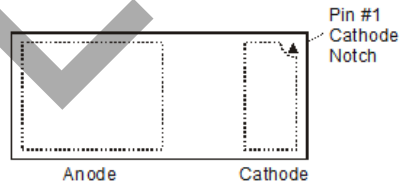
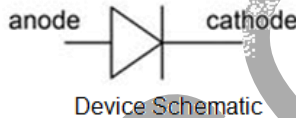
- Blocking diodes
- Boost diodes
- Switching diodes
- Reverse protection diodes

Features and Benefits

- Off Board Profile of 0.275mm — More than 30% Thinner than DFN1006
- Low Forward Voltage (V_F) Minimizes Conduction Losses and Improves Efficiency
- Reduced High Temperature Reverse Leakage; Increased Reliability Against Thermal Runaway Failure in High Temperature Operation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Mechanical Data

- Package: X3-WLB1006-2
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208(4)
- Polarity: Cathode Dot
- Weight: 0.001 grams (Approximate)

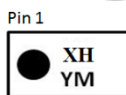


Ordering Information (Note 4)

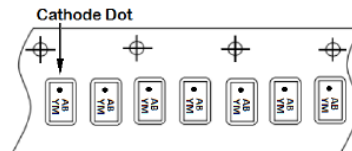
Part Number	Package	Packing	
		Qty.	Carrier
SDM1A30CSP-7	X3-WLB1006-2	5000	Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



XH = Product Type Marking Code
 YM = Date Code Marking
 Y or \bar{Y} = Year (ex: K = 2023)
 M = Month (ex: 9 = September)
 Dot Denotes Cathode Pin



Date Code Key

Year	2018	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	F	-	K	L	M	N	O	P	R	S	T	U

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	30	V
Average Rectified Output Current	I _o	1	A
Repetitive Peak Forward Current (Pulse Wave = 1ms, Duty Cycle = 25%)	I _{FRM}	4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	15	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	135	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	395	440	mV	I _F = 0.5A, T _J = +25°C
		—	475	525		I _F = 1.0A, T _J = +25°C
		—	425	—		I _F = 1.0A, T _J = +125°C
Leakage Current (Note 6)	I _R	—	6	20	μA	V _R = 10V, T _J = +25°C
		—	20	100		V _R = 30V, T _J = +25°C
		—	8	—	mA	V _R = 30V, T _J = +125°C
Junction Capacitance	C _T	—	40	—	pF	V _R = 4V, f = 1.0MHz

Notes: 5. Device mounted on FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
 6. Short duration pulse test used to minimize self-heating effect.

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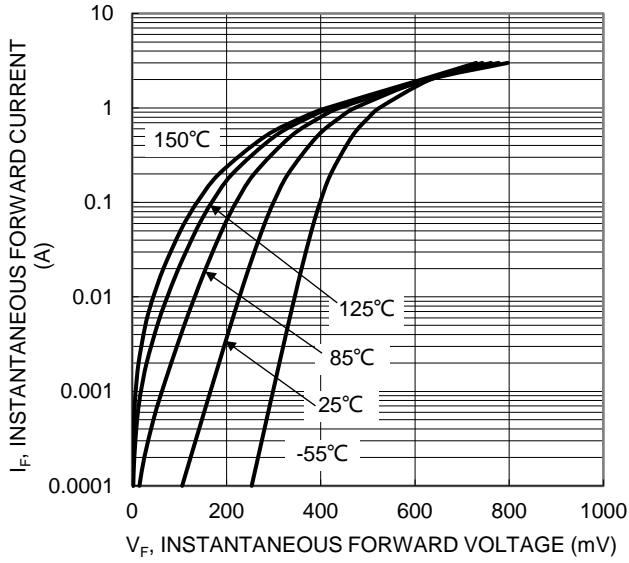


Figure.1 Typical Forward Characteristics

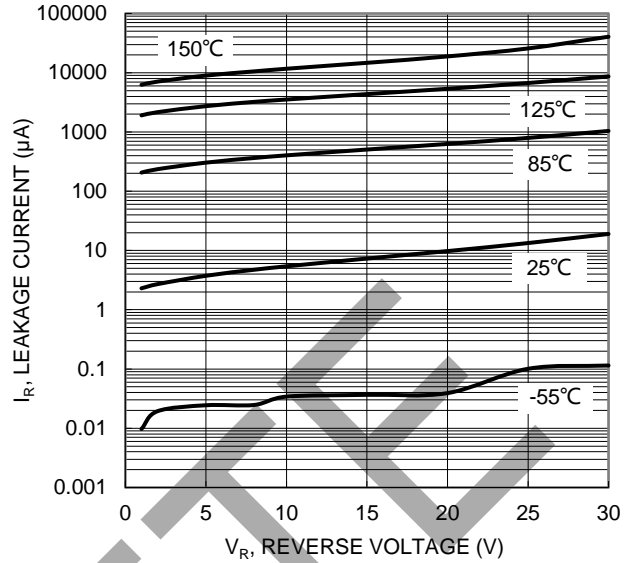


Figure 2. Typical Reverse Characteristics

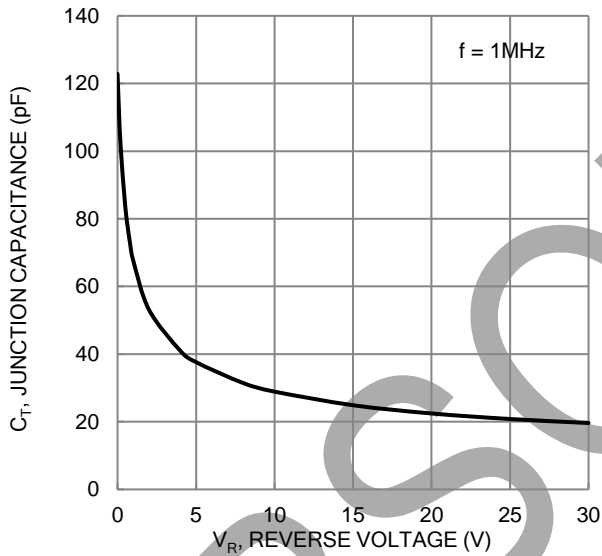
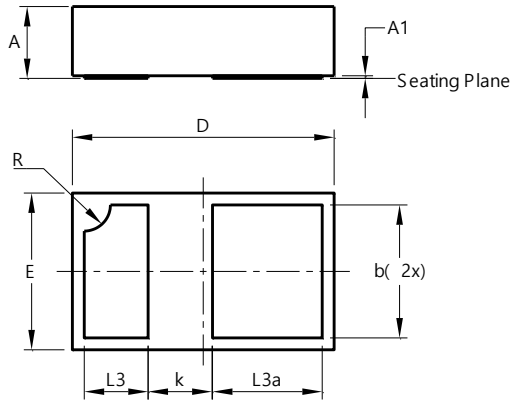


Figure 3. Typical Junction Capacitance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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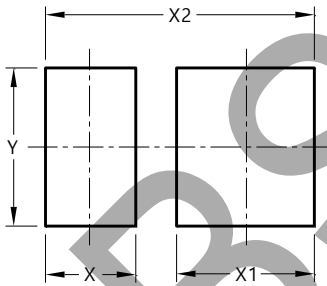


X3-WLB1006-2			
Dim	Min	Max	Typ
A	0.25	0.30	0.275
A1	0.00	0.01	-
b	0.450	0.550	0.500
D	0.95	1.05	1.000
E	0.55	0.65	0.600
k	-	-	0.288
L3	0.194	0.294	0.244
L3a	0.350	0.450	0.400
R	-	-	0.100
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X3-WLB1006-2



Dimensions	Value (in mm)
X	0.332
X1	0.507
X2	0.989
Y	0.579

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